

BCR08AM-12

Triac

Low Power Use

REJ03G0343-0100 Rev.1.00 Aug.20.2004

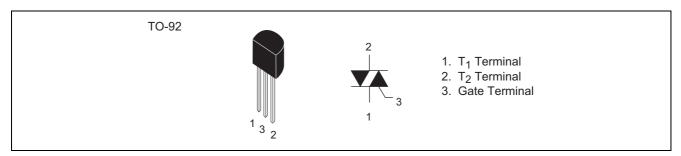
Features

 $\begin{array}{ll} \bullet & I_{T \, (RMS)} : 0.8 \; A \\ \bullet & V_{DRM} : 600 \; V \\ \end{array}$

 I_{RGTI}^{OM} , I_{RGTIII} : 5 mA

• Planar Passivation Type

Outline



Applications

Electric fan, air cleaner, and other general purpose control applications

Maximum Ratings

Parameter	Symbol	Voltage class	Unit	
Parameter	Syllibol	12		
Repetitive peak off-state voltage ^{Note1}	V_{DRM}	600	V	
Non-repetitive peak off-state voltage ^{Note1}	V_{DSM}	720	V	

Parameter	Symbol	Ratings	Unit	Conditions
RMS on-state current	I _{T (RMS)}	0.8	А	Commercial frequency, sine full wave 360° conduction, Tc = 56°C
Surge on-state current	I _{TSM}	8	А	60Hz sinewave 1 full cycle, peak value, non-repetitive
I ² t for fusing	l ² t	0.26	A ² s	Value corresponding to 1 cycle of half wave 60Hz, surge on-state current
Peak gate power dissipation	P_{GM}	1	W	
Average gate power dissipation	P _{G (AV)}	0.1	W	
Peak gate voltage	V_{GM}	6	V	
Peak gate current	I _{GM}	0.5	Α	
Junction temperature	Tj	- 40 to +125	°C	
Storage temperature	Tstg	- 40 to +125	°C	
e Mass im	_	0.23	g	Typical value

Notes: 1. Gate open.

Electrical Characteristics

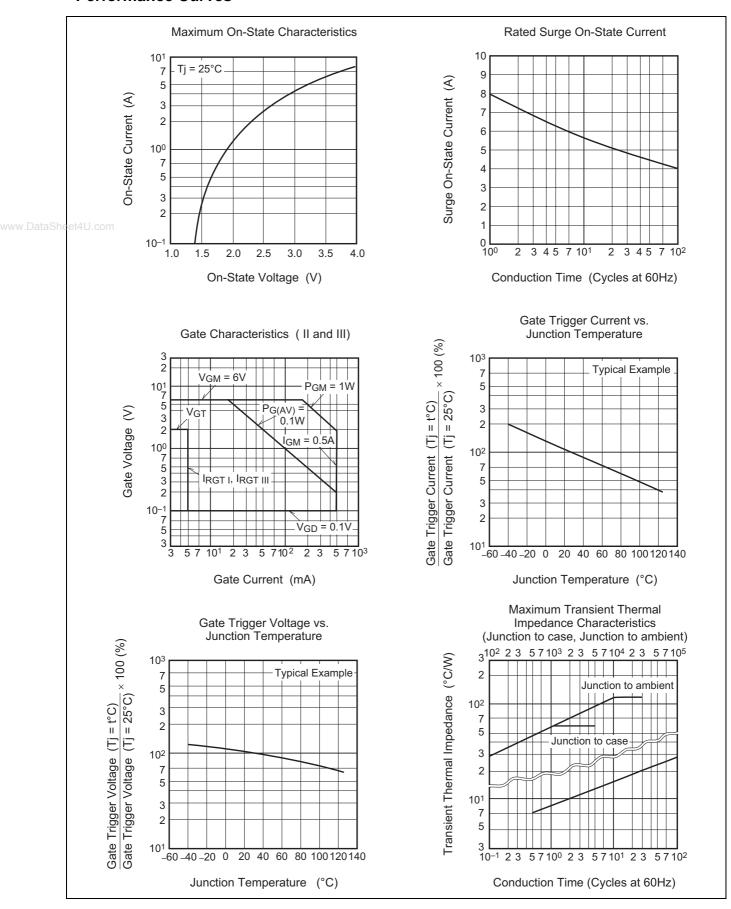
Parameter		Symbol	Min.	Тур.	Max.	Unit	Test conditions
Repetitive peak off-state current		I _{DRM}	_	_	1.0	mA	Tj = 125°C, V _{DRM} applied
On-state voltage		V_{TM}	_	_	2.0	V	Tc = 25°C, I _{TM} = 1.2 A, Instantaneous measurement
Gate trigger voltage ^{Note2}	II	V_{RGTI}	_	_	2.0	V	$Tj = 25$ °C, $V_D = 6$ V, $R_L = 6$ Ω,
	III	$V_{RGT_{III}}$	_	_	2.0	V	$R_G = 330 \Omega$
Gate trigger current ^{Note2}	II	I _{RGTI}	_	_	5	mA	$Tj = 25^{\circ}C, V_D = 6 V, R_L = 6 \Omega,$
	III	I _{RGTIII}	_	_	5	mA	$R_G = 330 \Omega$
Gate non-trigger voltage		V_{GD}	0.1	_	_	V	$Tj = 125$ °C, $V_D = 1/2 V_{DRM}$
Thermal resistance		R _{th (j-c)}		_	60	°C/W	Junction to case ^{Note3}
Critical-rate of rise of off-state commutating voltage ^{Note4}		(dv/dt)c	0.5	_	_	V/μs	Tj = 125°C

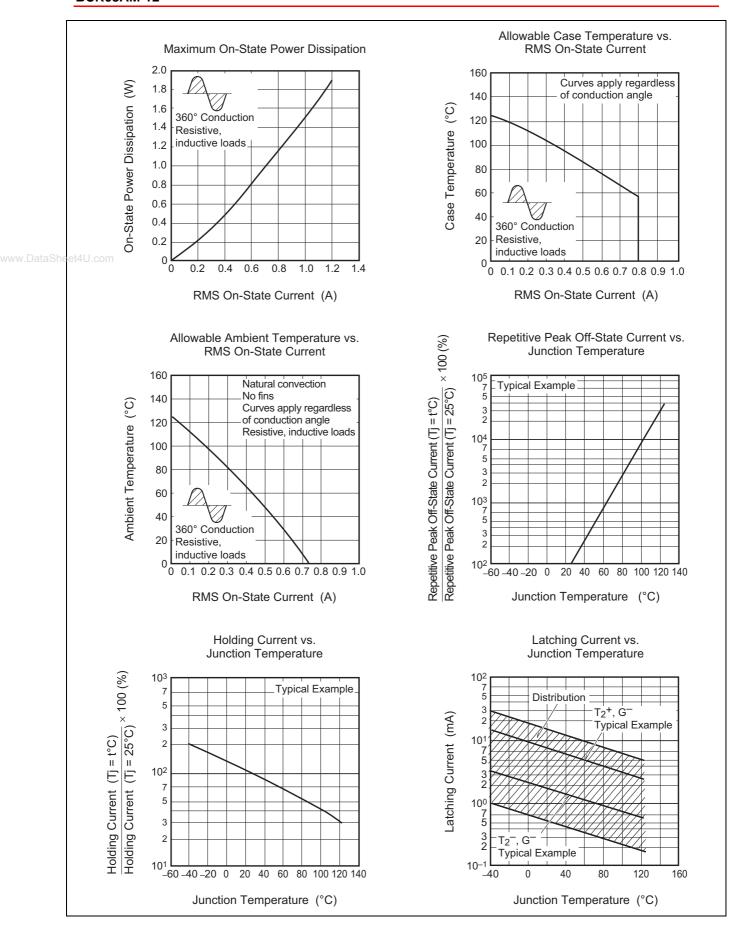
Notes: 2. Measurement using the gate trigger characteristics measurement circuit.

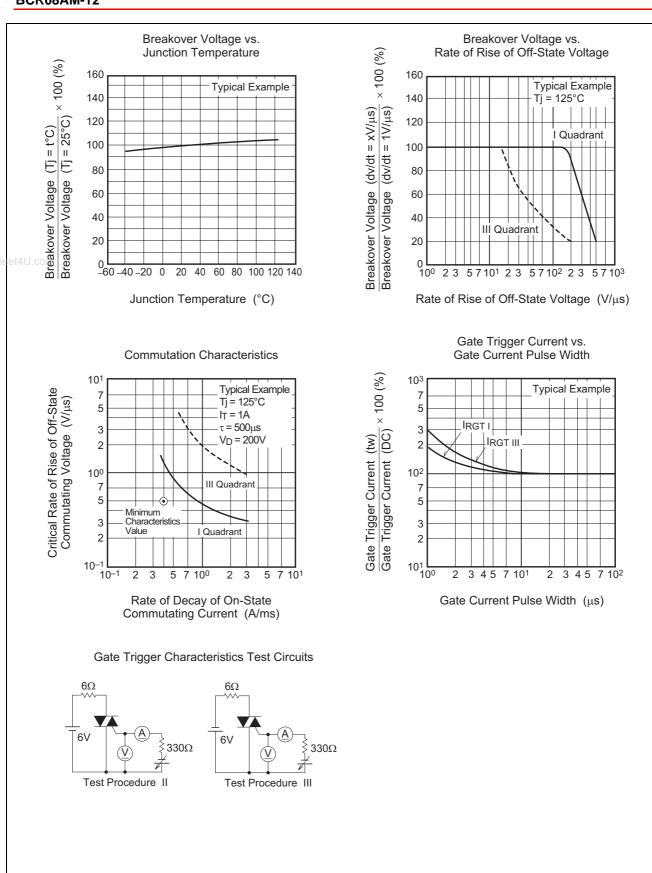
- 3. Case temperature is measured at the T_2 terminal 1.5 mm away from the molded case.
- 4. Test conditions of the critical-rate of rise of off-state commutating voltage is shown in the table below.

Test conditions	Commutating voltage and current waveforms (inductive load)		
1. Junction temperature Tj = 125°C	Supply Voltage → Time		
2. Rate of decay of on-state commutating current (di/dt)c = - 0.4 A/ms	Main Current (di/dt)c Time		
3. Peak off-state voltage $V_D = 400 \text{ V}$	Main Voltage Time		

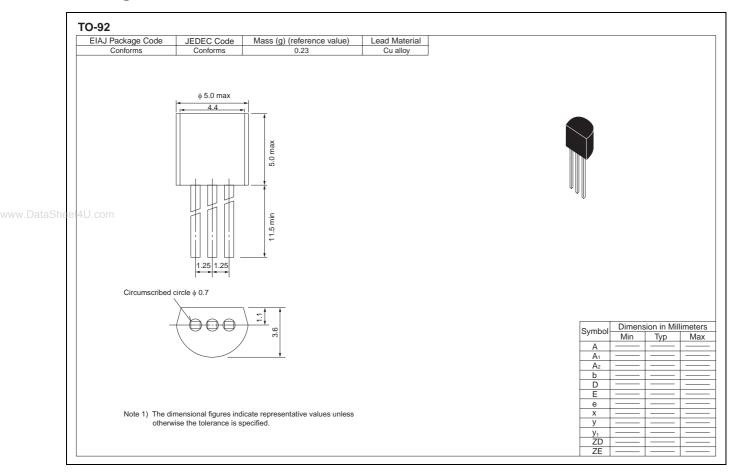
Performance Curves







Package Dimensions



Order Code

Lead form	Standard packing	Quantity	Standard order code	Standard order code example
Straight type	Vinyl sack	500	Type name +A	BCR08AM-12A
Lead form	Vinyl sack	500	Type name +A – Lead forming code	BCR08AM-12A-A6
Form A8	Taping	2000	Type name +A – TB	BCR08AM-12A-TB

Note: Please confirm the specification about the shipping in detail.

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